

DMP3025LK3

#### 30V P-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub> T <sub>A</sub> = 25°C
-30V	25mΩ @ V <sub>GS</sub> = -10V	-16.1A
	41mΩ @ V <sub>GS</sub> = -4.5V	-12.5A

### **Description and Applications**

This new generation MOSFET has been designed to minimize the onstate resistance ( $R_{DS(on)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- DC-DC Converters
- · Power management functions

#### **Features and Benefits**

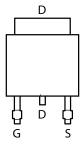
- · Low on-resistance
- Fast switching speed
- "Green" component and RoHS compliant (Note 1)

#### **Mechanical Data**

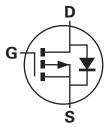
- Case: TO252-3L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals Connections: See Diagram
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See BelowOrdering Information: See Below
- Weight: 0.33 grams (approximate)



Top View



Pin Out -Top View



Equivalent Circuit

### Ordering Information (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel	
DMP3025LK3-13	P3025L	13	16	2,500	

Note:

# **Marking Information**



Oll = Manufacturer's Marking
P3025L = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 09 = 2009)
WW = Week (01-52)

<sup>1.</sup> Diodes, Inc. defines "Green" products as those which are Eu RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.





## **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Char	acteristic		Symbol	Value	Unit	
Drain-Source voltage			$V_{DSS}$	V <sub>DSS</sub> -30		
Gate-Source voltage			V <sub>GS</sub> ±20		V	
		(Note 3)	I <sub>D</sub>	-16.1		
Continuous Drain current	$V_{GS} = 10V$	T <sub>A</sub> =70°C (Note 3)		-12.9	Α	
		(Note 2)		-10.6		
Pulsed Drain current	V <sub>GS</sub> = 10V	(Note 4)	I <sub>DM</sub>	-41.9	Α	
Continuous Source current (Body diode) (Note 3)		I <sub>S</sub>	-12.6	Α		
Pulsed Source current (Body diode) (Note 4)		I <sub>SM</sub>	-41.9	A		

# Thermal Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
	(Note 2)		4.3 34.5	
Linear derating factor	(Note 3)	P <sub>D</sub>	10.0 80.0	W mW/°C
	(Note 5)		2.15 17.2	
Thermal Resistance, Junction to Ambient	(Note 2) (Note 3)	$R_{ hetaJA}$	29.0 12.5	°C/W
Thermal Resistance, Junction to Lead	(Note 5) (Note 6)	R <sub>0</sub> JL	58.0 1.02	°C/VV
Operating and storage temperature range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C

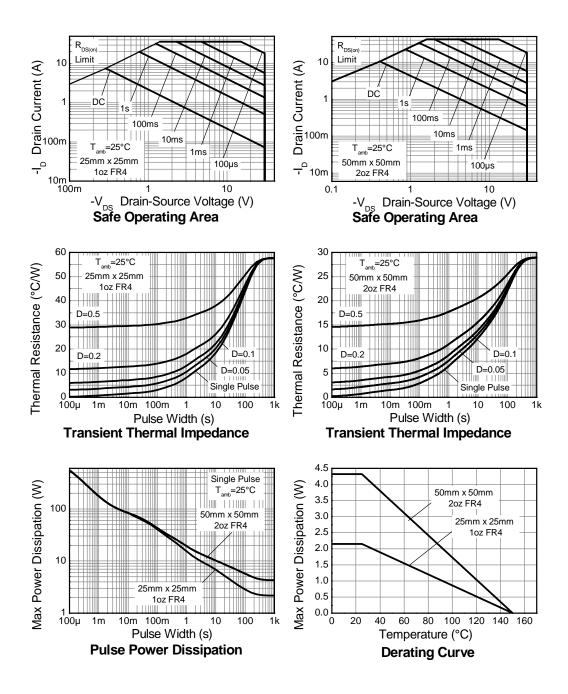
Notes:

- 2. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is

- 2. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
   3. Same as note 2, except the device is measured at t ≤ 10 sec.
   4. Same as note 2, except the device is pulsed with D = 0.02 and pulse width 300 μs. The pulse current is limited by the maximum junction temperature.
   5. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
   6. Thermal resistance from junction to solder-point (at the end of the drain lead).



### **Thermal Characteristics**







# Electrical Characteristics @TA = 25°C unless otherwise specified

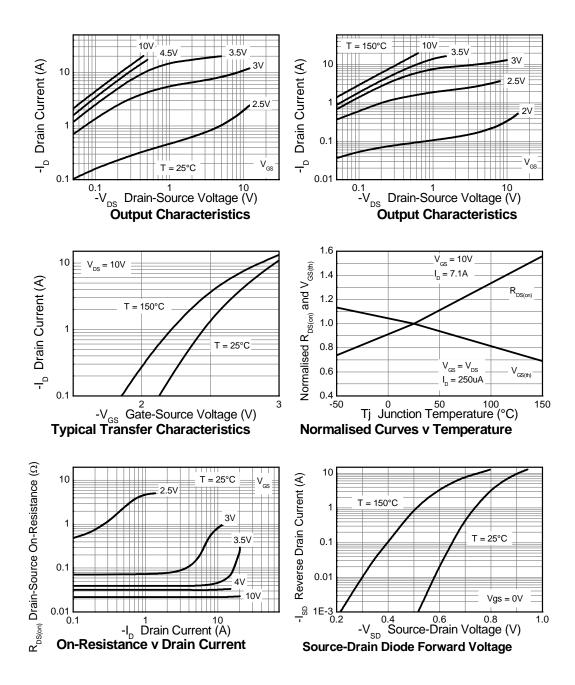
Characteristic	Symbol	Min	Тур	Max	Unit	Test	Condition	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	_	_	V	$I_D = -250 \mu A, V$	<sub>GS</sub> = 0V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	-0.5	μА	V <sub>DS</sub> = -30V, V <sub>0</sub>	GS= 0V	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	V <sub>GS</sub> = ±20V, V	DS= 0V	
ON CHARACTERISTICS								
Gate Threshold Voltage	V <sub>GS(th)</sub>	-1.0		-3.0	V	I <sub>D</sub> = -250μA, V	<sub>DS</sub> = V <sub>GS</sub>	
Static Drain-Source On-Resistance (Note 7)	Dec (cu)			0.025	Ω	$V_{GS}$ = -10 $V$ , $I_{D}$	= -7.1A	
Static Drain-Source On-Nesistance (Note 1)	R <sub>DS</sub> (ON)			0.041	12	V <sub>GS</sub> = -4.5V, I <sub>E</sub>	<sub>0</sub> = -5.5A	
Forward Transconductance (Notes 7 & 8)	g <sub>fs</sub>		18.6		S	$V_{DS}$ = -15V, $I_{DS}$	= -7.1A	
Diode Forward Voltage (Note 7)	$V_{SD}$		-0.80	-1.2	V	I <sub>S</sub> = -1.7A, V <sub>GS</sub>	S= 0V	
Reverse recovery time (Note 8)	t <sub>rr</sub>		16.2	_	ns	1- 2.24 di/dt 4.004/		
Reverse recovery charge (Note 8)	Qrr		10	_	nC	I <sub>S</sub> = -2.2A, di/dt= 100A/μs		
DYNAMIC CHARACTERISTICS (Note 8)								
Input Capacitance	C <sub>iss</sub>		1678	_	pF			
Output Capacitance	Coss		303	_	pF	V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V f= 1MHz		
Reverse Transfer Capacitance	C <sub>rss</sub>		178	_	pF	1= 1101112	_	
Total Gate Charge	Qg		16.5	_	nC	V <sub>GS</sub> = -4.5V		
Total Gate Charge	Qg		31.6		nC		V <sub>DS</sub> = -15V,	
Gate-Source Charge	$Q_{gs}$		4.3	_	nC	V <sub>GS</sub> = -10V I <sub>D</sub> = -7.1A		
Gate-Drain Charge	$Q_{gd}$	_	6.2	_	nC			
Turn-On Delay Time (Note 9)	t <sub>D(on)</sub>	_	3.5	_	ns			
Turn-On Rise Time (Note 9)	t <sub>r</sub>		4.9		ns	V <sub>DD</sub> = -15V, V <sub>GS</sub> = -10V		
Turn-Off Delay Time (Note 9)	t <sub>D(off)</sub>		44		ns	$I_D=$ -1A, $R_G\cong 6.0\Omega$		
Turn-Off Fall Time (Note 9)	t <sub>f</sub>		23	_	ns			

Notes:

- 7. Measured under pulsed conditions. Pulse width  $\leq 300 \mu s;$  duty cycle  $\leq 2\%$
- Newsday and a place contained in the water 200 pt, any cycle 22/8
   For design aid only, not subject to production testing.
   Switching characteristics are independent of operating junction temperatures.



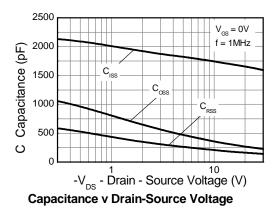
# **Typical Characteristics**

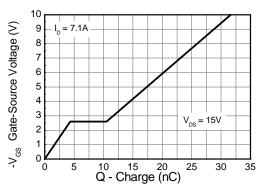






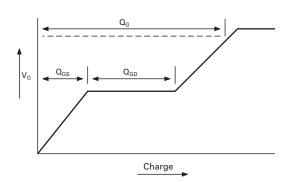
## **Typical Characteristics - continued**





Gate-Source Voltage v Gate Charge

### **Test Circuits**



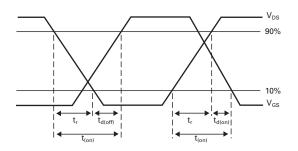
Current regulator

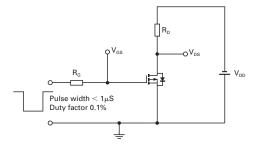
12V 0.2μF 50k Same as D.U.T

V<sub>os</sub>

Basic gate charge waveform

Gate charge test circuit



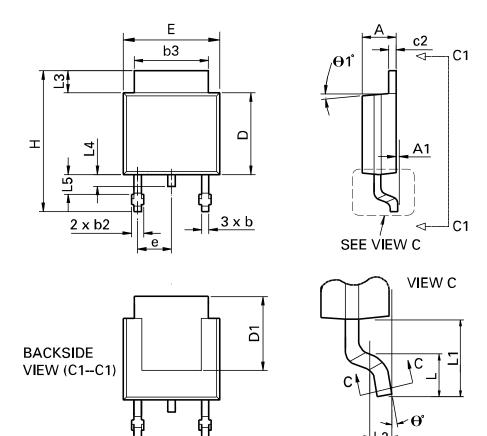


Switching time waveforms

Switching time test circuit



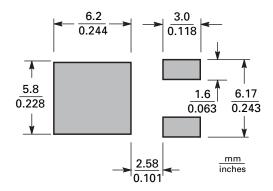
# **Package Outline Dimensions**



DIM	I Inches		Millimeters		DIM	Inches		Millimeters	
	Min	Max	Min	Max		Min	Max	Min	Max
Α	0.086	0.094	2.18	2.39	е	0.090 BSC		2.29 BSC	
<b>A</b> 1	-	0.005	-	0.127	н	0.370	0.410	9.40	10.41
b	0.020	0.035	0.508	0.89	L	0.055	0.070	1.40	1.78
b2	0.030	0.045	0.762	1.14	L1	0.108 REF		2.74 REF	
b3	0.205	0.215	5.21	5.46	L2	0.020 BSC		0.508 BSC	
С	0.018	0.024	0.457	0.61	L3	0.035	0.065	0.89	1.65
c2	0.018	0.023	0.457	0.584	L4	0.025	0.040	0.635	1.016
D	0.213	0.245	5.41	6.22	L5	0.045	0.060	1.14	1.52
D1	0.205	-	5.21	-	θ1°	0°	10°	0°	10°
E	0.250	0.265	6.35	6.73	θ°	0°	15°	0°	15°
E1	0.170	-	4.32	-	-	-	-	-	-



## Suggested Pad Layout



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